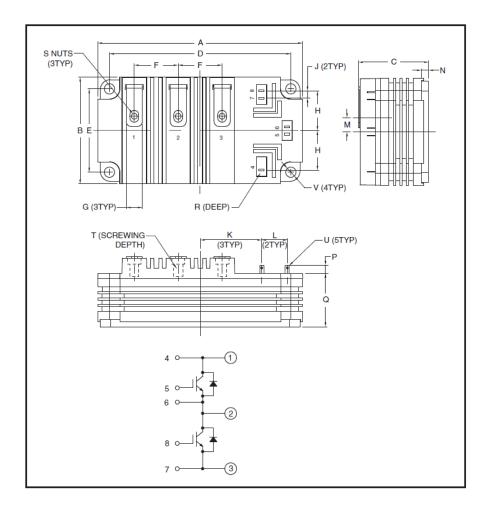




Powerex, Inc., 173 Pavilion Lane, Youngwood, Pennsylvania 15697 (724) 925-7272 www.pwrx.com

Dual IGBT HVIGBT Module 85 Amperes/6500 Volts



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
Α	5.51	140.0
В	2.87	73.0
С	1.89	48.0
D	4.88±0.01	124.0±0.25
Е	2.24±0.01	57.0±0.25
F	1.18	30.0
G	0.43	11.0
Н	1.07	27.15
J	0.20	5.0
K	1.65	42.0

Dimensions	Inches	Millimeters
L	0.69±0.01	17.5±0.25
М	0.38	9.75
N	0.20	5.0
Р	0.22	5.5
Q	1.44	36.5
R	0.16	4.0
S	M6 Metric	M6
Т	0.63 Min.	16.0 Min.
U	0.11 x 0.02	2.8 x 0.5
V	0.28 Dia.	7.0 Dia.



Description:

Powerex HVIGBTs feature highly insulating housings that offer enhanced protection by means of greater creepage and strike clearance distance for many demanding applications like medium voltage drives and auxiliary traction applications.

Features:

- ☐ -40 to 150°C Extended Temperature Range
- ☐ 100% Dynamic Tested
- □ 100% Partial Discharge Tested
- ☐ Advanced Mitsubishi R-Series Chip Technology
- ☐ Aluminum Nitride (AIN) Ceramic Substrate for Low Thermal Impedance
- ☐ Complementary Line-up in Expanding Current Ranges to Mitsubishi HVIGBT Power Modules
- ☐ Copper Baseplate
- ☐ Creepage and Clearance Meet IEC 60077-1
- ☐ Rugged SWSOA and RRSOA

Applications:

- ☐ High Voltage Power Supplies
- ☐ Medium Voltage Drives
- ☐ Motor Drives
- □ Traction



QID6508001 **Dual IGBT HVIGBT Module** 85 Amperes/6500 Volts

Absolute Maximum Ratings, T_i = 25 °C unless otherwise specified

Ratings	Symbol		QID6508001	Units
Junction Temperature	Тј		-40 to +150	°C
Storage Temperature	T _{stg}		-40 to +125	°C
Collector-Emitter Voltage (V _{GE} = 0V)	V _{CES}	T _j = -40°C	5800	Volts
		T _j = +25°C	6300	Volts
		T _j = +125°C	6500	Volts
Gate-Emitter Voltage (V _{CE} = 0V)	V _{GES}		±20	Volts
Collector Current (T _C = 110°C)	I _C		85	Amperes
Peak Collector Current (Pulse)	I _{CM}		170 ^{*2}	Amperes
Diode Forward Current (T _C = 102°C)*1	I _F		85	Amperes
Diode Forward Surge Current (Pulse)*1	I _{FM}		170* ²	Amperes
Maximum Collector Dissipation	PC		1100	Watts
$(T_C = 25^{\circ}C, IGBT Part, T_{j(max)} :s 150^{\circ}C)$				
Mounting Torque, M6 Terminal Screws	_		44	in-lb
Mounting Torque, M6 Mounting Screws	_		44	in-lb
Module Weight (Typical)	_		900	Grams
Isolation Voltage (Charged Part to Baseplate, AC 60Hz 1 min.)	V _{iso}		10.2	kVolts
Partial Discharge	Q _{pd}		10	рС
$(V1 = 6900 V_{RMS}, V2 = 5200 V_{RMS}, f = 60Hz (Acc. to IEC 1287))$)			
Maximum Short-Circuit Pulse Width,	t _{psc}		10	μs
$(V_{CC} \le 4500V, V_{GE} = \pm 15V, T_j = 125^{\circ}C)$				

Electrical Characteristics, $T_j = 25$ °C unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Collector-Cutoff Current	I _{CES}	$V_{CE} = V_{CES}$, $V_{GE} = 0V$, $T_j = 25$ °C	_	_	3	mA
		$V_{CE} = V_{CES}$, $V_{GE} = 0V$, $T_j = 125$ °C	_	3	_	mA
Gate Leakage Current	I _{GES}	$V_{GE} = V_{GES}$, $V_{CE} = 0V$	_	_	0.5	μΑ
Gate-Emitter Threshold Voltage	V _{GE(th)}	$I_{C} = 13mA, V_{CE} = 10V$	5.8	6.3	6.8	Volts
Collector-Emitter Saturation Voltage	V _{CE(sat)}	$I_C = 85A$, $V_{GE} = 15V$, $T_j = 25$ °C	_	3.8*3	_	Volts
		$I_C = 85A, V_{GE} = 15V, T_j = 125$ °C	_	4.8	5.6	Volts
Total Gate Charge	Q_{G}	$V_{CC} = 3600V$, $I_{C} = 85A$, $V_{GE} = 15V$	_	1.05	_	μC
Emitter-Collector Voltage*1	V _{EC}	I _E = 85A, V _{GE} = 0V, T _j = 25°C	_	3.3	_	Volts
		I _E = 85A, V _{GE} = 0V, T _j = 125°C	_	3.4	4.2	Volts

^{*1} Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).
*2 Pulse width and repetition rate should be such that device junction temperature (T_j) does not exceed T_{j(max)} rating.
*3 Pulse width and repetition rate should be such that device junction temperature rise is negligible.



QID6508001 Dual IGBT HVIGBT Module 85 Amperes/6500 Volts

Electrical Characteristics, $T_i = 25$ °C unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Input Capacitance	C _{ies}			15	_	nF
Output Capacitance	C _{oes}	$V_{GE} = 0V$, $V_{CE} = 10V$		0.95	_	nF
Reverse Transfer Capacitance	C _{res}	f = 100kHz	_	0.44	_	nF
Turn-on Delay Time	t _{d(on)}	$V_{CC} = 3200V, I_{C} = 85A,$	_	0.55	_	μs
Rise Time	t _r	$V_{GE} = \pm 15V$,	_	0.2	_	μs
Turn-off Delay Time	t _{d(off)}	$R_{G(on)} = 30\Omega$, $R_{G(off)} = 300\Omega$,		9.55	_	μs
Fall Time	t _f	Inductive Load	_	0.61	_	μs
Turn-on Switching Energy	E _{on}	$T_j = 125$ °C, $I_C = 85A$, $V_{GE} = \pm 15V$,	_	460	_	mJ
Turn-off Switching Energy	E _{off}	$R_{G(on)} = 30\Omega$, $R_{G(off)} = 300\Omega$, $V_{CC} = 3200V$, Inductive Load	_	500	_	mJ
Diode Reverse Recovery Time*1	t _{rr}	$V_{CC} = 3200V, I_E = 85A,$	_	0.7	_	μs
Diode Reverse Recovery Charge*1	Q _{rr}	$V_{GE} = \pm 15V, R_{G(on)} = 30\Omega,$		100*3	_	μC
Diode Reverse Recovery Energy	E _{rec}	Inductive Load, T _j = 125°C		200	_	mJ
Stray Inductance (C1-E2)	L _{SCE}		_	60	_	nΗ
Lead Resistance Terminal-Chip	R _{CE}		_	0.8	_	mΩ

Thermal and Mechanical Characteristics, T_j = 25 °C unless otherwise specified

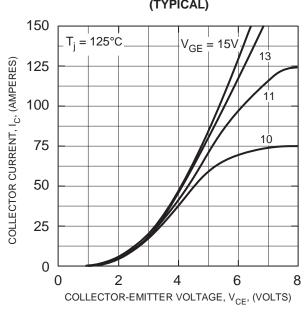
Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Thermal Resistance, Junction to Case*4	R _{th(j-c)} Q	Per IGBT	_	0.100	_	°C/W
Thermal Resistance, Junction to Case*4	R _{th(j-c)} D	Per FWDi	_	0.175	_	°C/W
Contact Thermal Resistance, Case to Fin	R _{th(c-f)}	Per Module,	_	0.018	_	°C/W
		Thermal Grease Applied, Agrease = 1W/mK				
Comparative Tracking Index	CTI		600	_	_	
Clearance Distance in Air	d _{a(t-t)}		19	_	_	mm
(Terminal to Terminal)						
Creepage Distance Along Surface	d _{s(t-t)}		54	_	_	mm
(Terminal to Terminal)						

^{*1} Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).
*3 Pulse width and repetition rate should be such that device junction temperature rise is negligible.
*4 T_C measurement point is just under the chips.

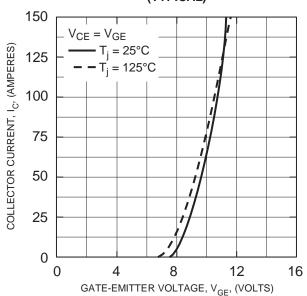


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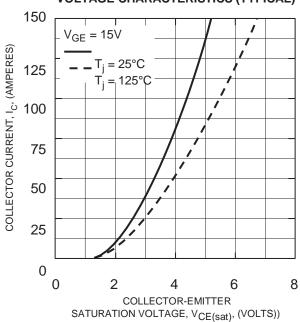




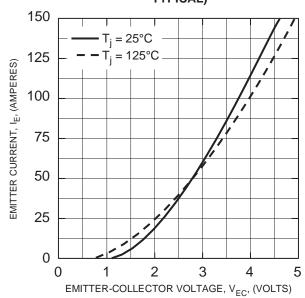
TRANSFER CHARACTERISTICS (TYPICAL)







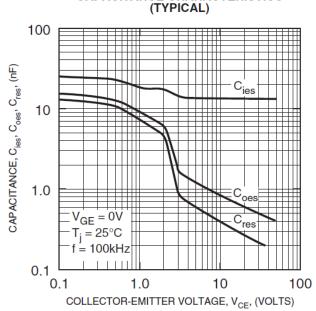
FREE-WHEEL DIODE FORWARD CHARACTERISTICS TYPICAL)



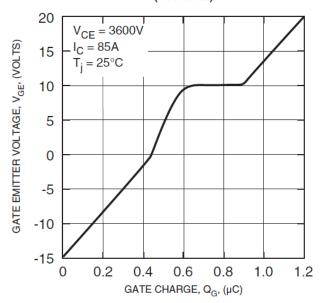


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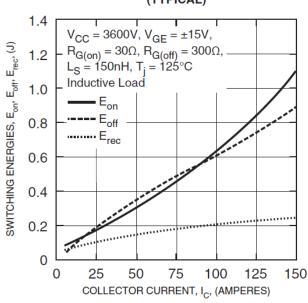
CAPACITANCE CHARACTERISTICS



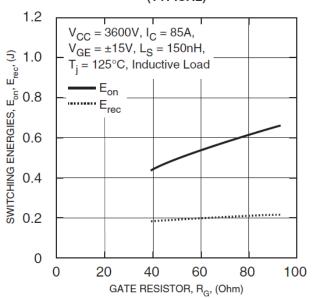
GATE CHARGE CHARACTERISTICS (TYPICAL)



HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)

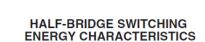


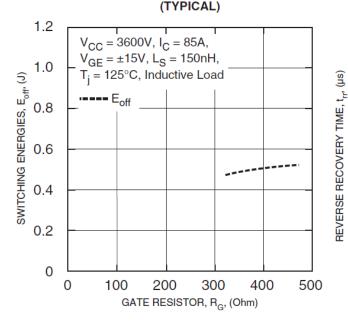
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



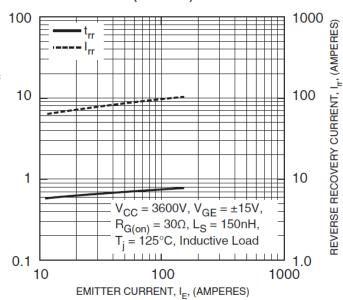


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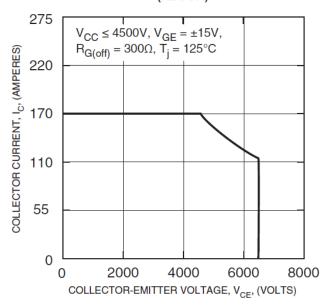




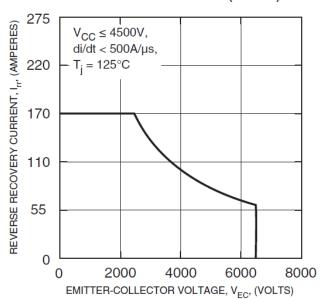
FREE-WHEEL DIODE REVERSE RECOVERY (TYPICAL)



REVERSE BIAS SAFE OPERATING AREA (RBSOA)



FREE-WHEEL DIODE REVERSE RECOVERY SAFE OPERATING AREA (RRSOA)





QID6508001 Dual IGBT HVIGBT Module 85 Amperes/6500 Volts

